Product data sheet

1. General description

NextPower 100 V, enhanced logic level gate drive MOSFET in an MLPAK33 (SOT8002) Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- · Logic-level compatible
- Low Q_{rr} for higher efficiency and lower spiking
- Low $Q_G \times R_{DSon}$ FOM for high efficiency switching applications
- Strong avalanche energy rating (E_{AS}) and 100% tested
- Ha-free and RoHS compliant MLPAK33 package
- Thermally efficient package in a small form factor (3.3 mm x 3.3 mm footprint)

3. Applications

- Synchronous rectifier in AC-DC and DC-DC
- Primary side switch 48 V DC-DC
- · BLDC motor control
- · USB-PD adapters
- · Full-bridge and half-bridge applications
- · Flyback and resonant topologies

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 150 °C	-	-	100	V
V _{GS}	gate-source voltage	T _j = 25 °C	-20	-	20	V
I _D	drain current	V _{GS} = 10 V; T _{mb} = 25 °C	-	-	44	Α
P _{tot}	total power dissipation	T _{mb} = 25 °C	-	-	50	W
Tj	junction temperature		-55	-	150	°C
Static characte	eristics					
R _{DSon}	drain-source on-state	V_{GS} = 10 V; I_D = 8.2 A; T_j = 25 °C	-	11.8	14.4	mΩ
resistance	resistance	V_{GS} = 4.5 V; I_D = 7.2 A; T_j = 25 °C	-	15	19	mΩ
Dynamic char	acteristics					
Q_{GD}	gate-drain charge	$V_{DS} = 50 \text{ V}; I_D = 8.2 \text{ A}; V_{GS} = 10 \text{ V};$	-	4.9	-	nC
Q _{G(tot)}	total gate charge	T _j = 25 °C	-	33	46	nC



Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Avalanche rug	Avalanche ruggedness						
E _{DS(AL)S}	non-repetitive drain- source avalanche energy	$V_{sup} \le 100 \text{ V; } V_{GS} = 10 \text{ V;}$ $T_{j(init)} = 25 \text{ °C; } R_{GS} = 50 \Omega; I_D = 5.8 \text{ A;}$ unclamped	[1]	-	-	232	mJ

[1] Protected by 100% test

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S	source	1 2 3 4	
2	S	source	رث ث ث	
3	S	source		D ⊥
4	G	gate		
5	D	drain		
6	D	drain	L'anay L'ana	mbb076 S
7	D	drain	8 7 6 5	
8	D	drain	MLPAK33 (SOT8002-1)	

6. Ordering information

Table 3. Ordering information

Type number	Package	ckage						
	Name	Description	Version					
PXN014-100QE		plastic thermal enhanced surface mounted package; mini leads; 8 terminals; pitch 0.65 mm; 3.3 x 3.3 x 0.8 mm body	SOT8002-1					

7. Marking

Table 4. Marking codes

Type number	Marking code
PXN014-100QE	1NW

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 150 °C		-	100	V
V _{GS}	gate-source voltage	T _j = 25 °C		-20	20	V
I _D	drain current	V _{GS} = 10 V; T _{amb} = 25 °C; t ≤ 5 s	[1]	-	14	Α
		V _{GS} = 10 V; T _{amb} = 25 °C	[1]	-	8.2	Α
		V _{GS} = 10 V; T _{mb} = 25 °C		-	44	Α
I _{DM}	peak drain current	T _{amb} = 25 °C; single pulse; t _p ≤ 10 μs		-	176	Α
P _{tot}	total power dissipation	T _{amb} = 25 °C	[1]	-	1.8	W
		T _{mb} = 25 °C		-	50	W
Tj	junction temperature			-55	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C
Source-drain	diode					
Is	source current	T _{amb} = 25 °C	[1]	-	1.8	А
		T _{mb} = 25 °C		-	44	Α
Avalanche rug	gedness			'		
E _{DS(AL)S}	non-repetitive drain- source avalanche energy	$V_{sup} \le 100 \text{ V}; V_{GS} = 10 \text{ V}; T_{j(init)} = 25 \text{ °C};$ $R_{GS} = 50 \Omega; I_D = 25.2 \text{ A}; unclamped$	[2]	-	61	mJ
		$V_{sup} \le 100 \text{ V}; V_{GS} = 10 \text{ V}; T_{j(init)} = 25 \text{ °C};$ R _{GS} = 50 Ω; I _D = 5.8 A; unclamped	[2]	-	232	mJ
I _{AS}	non-repetitive avalanche current	$T_{j(init)} = 25 ^{\circ}C$	[2]	-	25.2	A

- [1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm².
- [2] Protected by 100% test

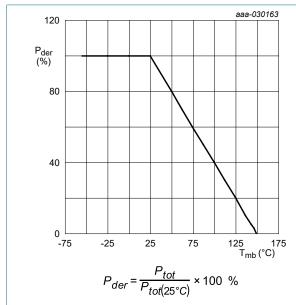


Fig. 1. Normalized total power dissipation as a function of mounting base temperature

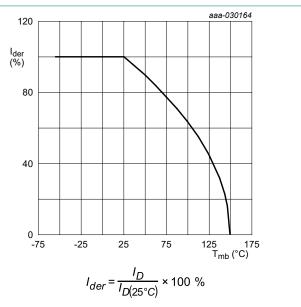


Fig. 2. Normalized continuous drain current as a function of mounting base temperature

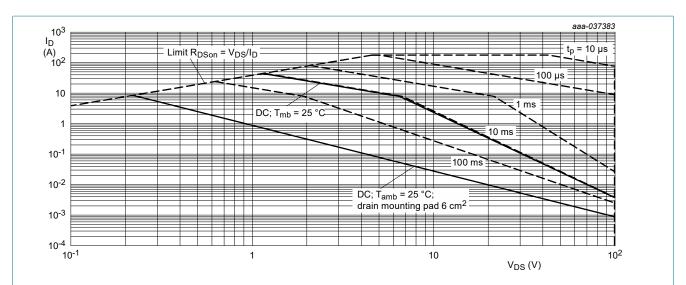


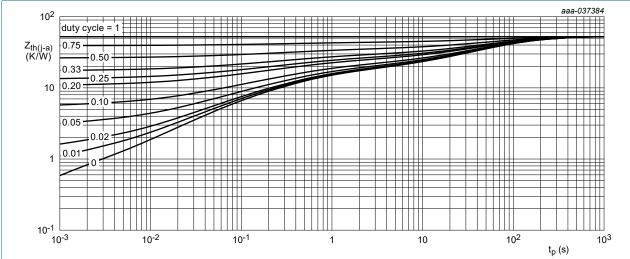
Fig. 3. Safe operating area; junction to ambient; continuous and peak drain currents as a function of drain-source voltage

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-a)} thermal resistance	thermal resistance from	in free air [1	[1]	-	145	185	K/W
	junction to ambient	[2]	-	55	70	K/W	
		in free air; t ≤ 5 s	[2]	-	21	26	K/W
$R_{th(j-mb)}$	thermal resistance from junction to mounting base			-	1.7	2.5	K/W

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 6 cm².



FR4 PCB, mounting pad for drain 6 cm²

Fig. 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

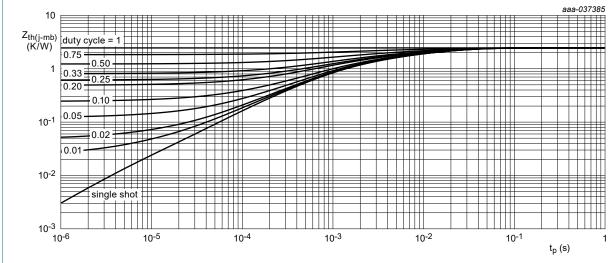


Fig. 5. Transient thermal impedance from junction to mounting base as a function of pulse duration; maximum

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	acteristics					
V _{(BR)DSS}	drain-source breakdown voltage	$I_D = 250 \mu A; V_{GS} = 0 V; T_j = 25 °C$	100	-	-	V
V_{GSth}	gate-source threshold voltage	$I_D = 250 \mu A; V_{DS} = V_{GS}; T_j = 25 \text{ °C}$	1.2	1.6	2.5	V
I _{DSS}	drain leakage current	V _{DS} = 100 V; V _{GS} = 0 V; T _j = 25 °C	-	-	1	μA
		V _{DS} = 100 V; T _j = 85 °C	-	-	20	μA
I _{GSS}	gate leakage current	$V_{GS} = 20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	-	100	nA
		$V_{GS} = -20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$ $V_{GS} = 10 \text{ V}; I_D = 8.2 \text{ A}; T_j = 25 \text{ °C}$ $V_{GS} = 10 \text{ V}; I_D = 8.2 \text{ A}; T_j = 150 \text{ °C}$ $V_{GS} = 4.5 \text{ V}; I_D = 7.2 \text{ A}; T_j = 25 \text{ °C}$ $V_{DS} = 10 \text{ V}; I_D = 8.2 \text{ A}; T_j = 25 \text{ °C}$ $I_D = 8.2 \text{ A}; I_D = 8.2 A$	-	-	-100	nA
R _{DSon}	drain-source on-state	$V_{GS} = 10 \text{ V}; I_D = 8.2 \text{ A}; T_j = 25 \text{ °C}$	-	11.8	14.4	mΩ
	resistance	V _{GS} = 10 V; I _D = 8.2 A; T _j = 150 °C	-	21	26	mΩ
		$V_{GS} = 4.5 \text{ V}; I_D = 7.2 \text{ A}; T_j = 25 \text{ °C}$	-	15	19	mΩ
9 _{fs}	forward transconductance	$V_{DS} = 10 \text{ V}; I_D = 8.2 \text{ A}; T_j = 25 \text{ °C}$	-	25	-	S
R_G	gate resistance	f = 1 MHz	-	1	-	Ω
Dynamic ch	aracteristics				1	
Q _{G(tot)}	T _j = 25 °C	V_{DS} = 50 V; I_{D} = 8.2 A; V_{GS} = 10 V; T_{j} = 25 °C	-	33	46	nC
		V_{DS} = 50 V; I_{D} = 8.2 A; V_{GS} = 4.5 V; T_{j} = 25 °C	-	16	24	nC
Q _{GS}	gate-source charge	T_j = 25 °C V_{DS} = 50 V; I_D = 8.2 A; V_{GS} = 4.5 V; T_j = 25 °C V_{DS} = 50 V; I_D = 8.2 A; V_{GS} = 10 V; T_j = 25 °C	-	5.3	-	nC
Q_{GD}	gate-drain charge		-	4.9	-	nC
C _{iss}	input capacitance	$V_{DS} = 50 \text{ V}; I_D = 8.2 \text{ A}; V_{GS} = 4.5 \text{ V};$ $T_j = 25 \text{ °C}$ $V_{DS} = 50 \text{ V}; I_D = 8.2 \text{ A}; V_{GS} = 10 \text{ V};$	-	2154	-	pF
C _{oss}	output capacitance	T _j = 25 °C	-	372	-	pF
C _{rss}	reverse transfer capacitance		-	11	-	pF
t _{d(on)}	turn-on delay time	V _{DS} = 50 V; I _D = 8.2 A; V _{GS} = 10 V;	-	6	-	ns
t _r	rise time	$R_{G(ext)} = 5 \Omega; T_j = 25 ^{\circ}C$	-	5	-	ns
t _{d(off)}	turn-off delay time		-	32	-	ns
t _f	fall time	1	-	11	-	ns
Q _{OSS}	output charge	$V_{DS} = 50 \text{ V}; f = 1 \text{ MHz}; V_{GS} = 0 \text{ V};$ $T_i = 25 ^{\circ}\text{C}$	-	33	-	nC
Source-drai	in diode			-	1	
V _{SD}	source-drain voltage	I _S = 1.8 A; V _{GS} = 0 V; T _j = 25 °C	-	0.7	1.2	V
t _{rr}	reverse recovery time	$I_S = 1.8 \text{ A}$; $dI_S/dt = -100 \text{ A/µs}$;	-	49	-	ns
Q _r	recovered charge	$V_{GS} = 0 \text{ V}; V_{DS} = 50 \text{ V}; T_j = 25 \text{ °C}$	-	43	_	nC

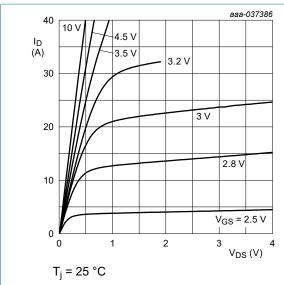


Fig. 6. Output characteristics: drain current as a function of drain-source voltage; typical values

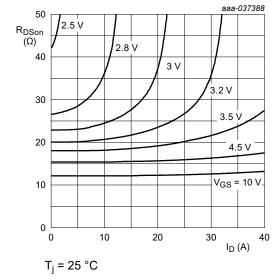


Fig. 8. Drain-source on-state resistance as a function of drain current; typical values

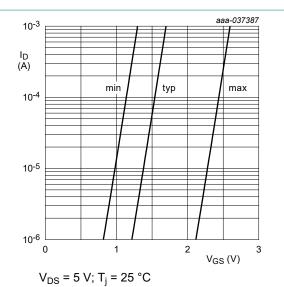


Fig. 7. Sub-threshold drain current as a function of gate-source voltage

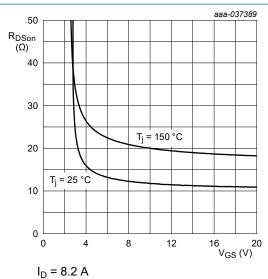


Fig. 9. Drain-source on-state resistance as a function of gate-source voltage; typical values

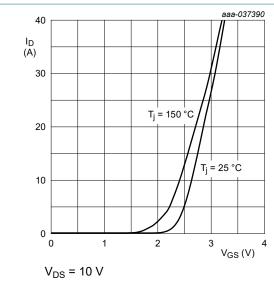


Fig. 10. Transfer characteristics: drain current as a function of gate-source voltage; typical values

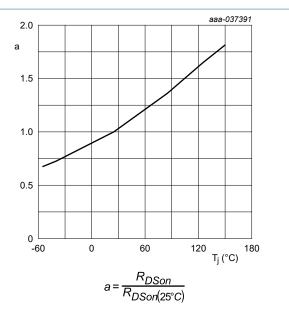


Fig. 11. Normalized drain-source on-state resistance as a function of junction temperature; typical values

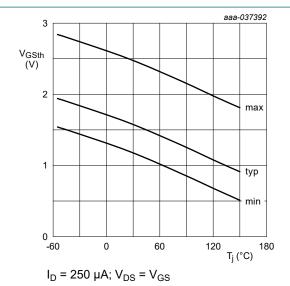


Fig. 12. Gate-source threshold voltage as a function of junction temperature

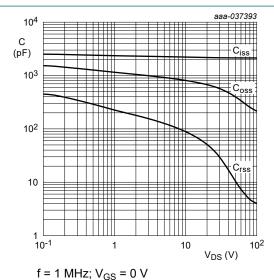


Fig. 13. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values

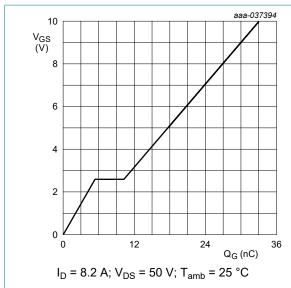


Fig. 14. Gate-source voltage as a function of gate charge; typical values

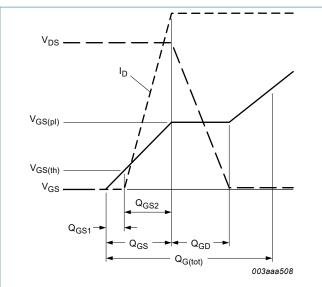


Fig. 15. Gate charge waveform definitions

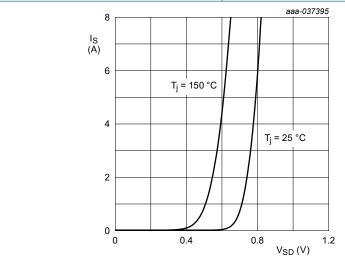
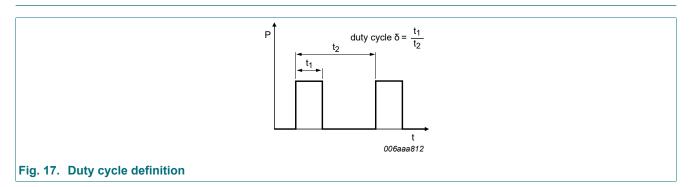


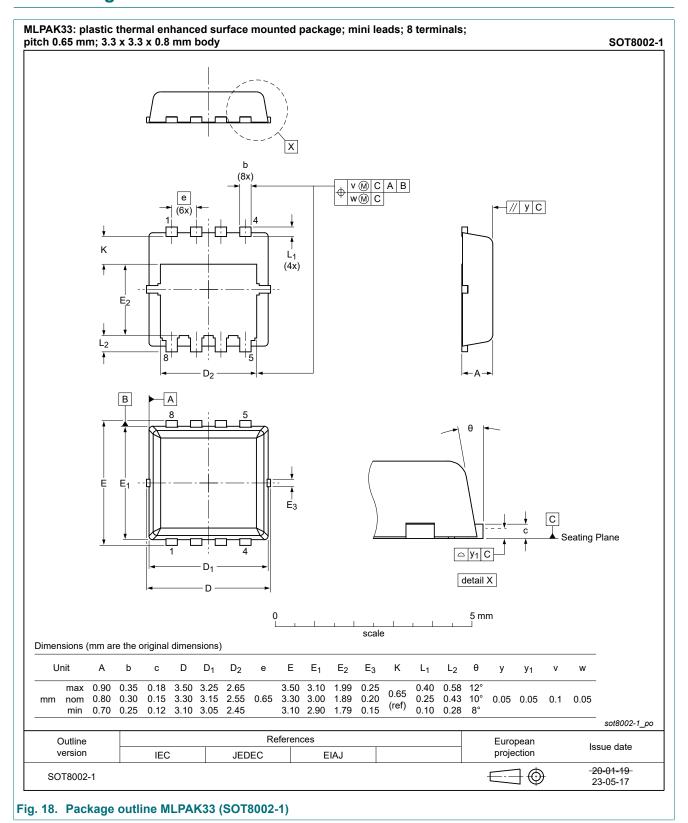
Fig. 16. Source current as a function of source-drain voltage; typical values

11. Test information

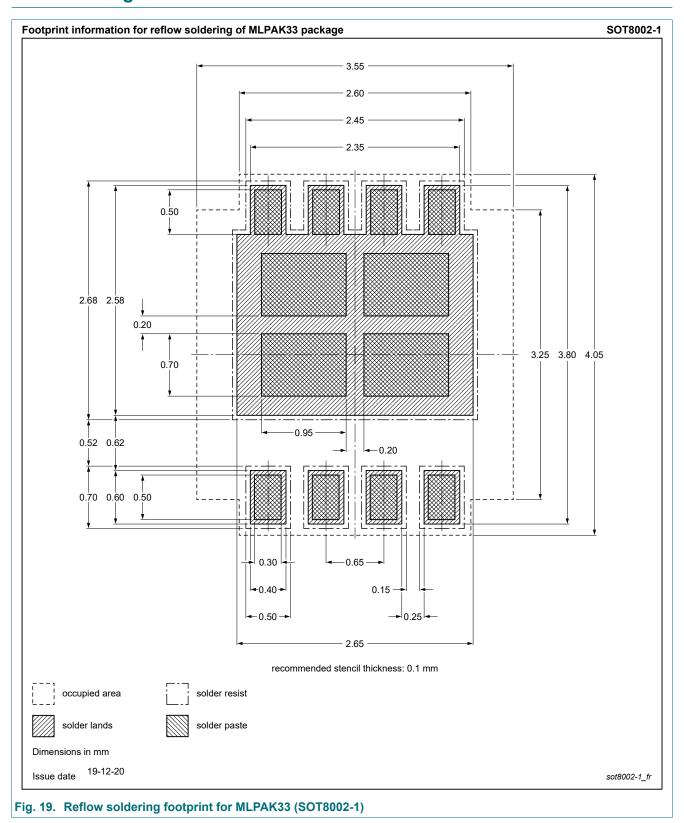
 $V_{GS} = 0 V$



12. Package outline



13. Soldering



14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PXN014-100QE v.1	20230925	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
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	Features and benefits

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